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## CLAIMS

- 1. A method of deposition of films of coating materials on a substrate, particular for deposition superconductive oxides and/or buffer layers of superconductive composite tapes, comprising a step of deposition of a film (2) 5 on the substrate (4) associated to a step of gas treatment in situ, in which a flow (13) of gas is sent towards a working surface (14) of the substrate (4) or of the film (2) growing on the substrate, the method being characterized in that said gas-treatment step comprises a step of ultrasound expansion of 10 the flow (13) of gas delivered.
  - 2. The method according to Claim 1, characterized in that the deposition step is a vacuum deposition step.
  - 3. The method according to Claim 1 or Claim 2, characterized in that the gas-treatment step is performed before, after, or during the deposition step.
- 4. The method according to any one of Claims 1 to 20 characterized in that the gas-treatment step is a step of oxygenation, the flow (13) of gas being a flow of oxygen.
- 5. The method according to any one of Claims 1 to characterized in that the gas-treatment step is a reducing step performed with forming gas, for example an argon/hydrogen mixture.
- 6. The method according to any one of the preceding claims, characterized in that the step of ultrasound expansion is 30 performed via at least one ultrasound-expansion nozzle (26), through which the flow (13) of gas is delivered, said nozzle being designed to generate a delivery area (40), in which at far as a distance of approximately 5 mm approximately 10 mm from the nozzle there is an oxygen 35 pressure approximately ten times the oxygen pressure outside

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the delivery area.

- 7. The method according to the preceding claim, characterized in that said nozzle (26) has a ratio between the inlet cross section and the outlet cross section comprised between approximately 1:2 and approximately 1:20.
- 8. The method according to any one of the preceding claims, characterized in that the gas-treatment step is performed cyclically.
- 9. The method according to any one of the preceding claims, characterized in that the deposition step and the gastreatment step are performed in a vacuum chamber (6), and the step of treatment comprises a step of pressurization of the flow (13) of gas prior to said step of ultrasound expansion.
- 10. The method according to the preceding claim, characterized in that, in the deposition step, the substrate (4) is carried through an evaporation area (16) formed within the chamber (6).
- 11. The method according to the preceding claim, characterized in that the substrate (4) is tape-shaped and is fed continuously through the evaporation area (16).
  - 12. The method according to Claim 10 or Claim 11, characterized in that the substrate (4) traverses the evaporation area (16) along a substantially curved path and the evaporation area (16) is radially internal to said path.
- 13. An apparatus (1) \*for deposition of films of coating materials on a substrate, in particular for deposition of films of superconductive oxides and/or buffer layers of superconductive composite tapes, comprising a chamber (6), inside which are housed deposition means (10) for forming a

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- film (2) of coating material on a face (11) of the substrate (4) and gas-treatment means (12) for delivering a flow (13) of gas on a working surface (14) of the substrate or of the film growing on the substrate, the apparatus being characterized in that the gas-treatment means (12) comprise at least one ultrasound-expansion nozzle (26), through which said flow (13) of gas is delivered while undergoing ultrasound expansion.
- 14. The apparatus according to Claim 13, characterized in that 10 said chamber (6) is a vacuum chamber.
- 15. The apparatus according to Claim 13 or Claim 14, characterized in that said nozzle (26) is designed to generate a delivery area (40), in which at least as far as a distance of approximately 5 mm from the nozzle there is an oxygen pressure approximately at least ten times the oxygen pressure in the chamber (6).
- 16. The apparatus according to Claim 15, characterized in that said nozzle (26) has a ratio between the inlet cross section and the outlet cross section comprised between approximately 1:2 and approximately 1:20.
- 17. The apparatus according to any one of Claims 13 to 16, characterized in that the deposition means (10) comprise evaporation means (15) for forming an evaporation area (16).
- 18. The apparatus according to Claim 17, characterized in that the gas-treatment means (12) comprise at least one diffuser (25) provided with a plurality of ultrasound-expansion nozzles (26), and moving means (27) for bringing said diffuser (25) cyclically within the evaporation area (16).
- 19. The apparatus according to Claim 17 or Claim 18, 35 characterized in that it comprises pressurization means (28) for feeding gas under pressure to said gas-treatment means

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- 20. The apparatus according to any one of Claims 17 to 19, characterized in that it comprises feed means (17) for carrying the substrate (4) through the evaporation area (16).
  - 21. The apparatus according to Claim 20, characterized in that the substrate (4) is tape-shaped, and the feed means (17) are continuous-feed means for feeding the substrate through the evaporation area (16) continuously.
- 22. The apparatus according to Claim 20 or Claim 21, characterized in that the feed means (17) define a substantially curved path of the substrate (4) through the evaporation area (16), and the evaporation means (15) are set radially internal to said path.